

SCTWA30N120

Silicon carbide Power MOSFET 1200 V, 45 A, 90 mΩ (typ., T_J= 150 °C), in an HiP247[™] long leads package

Datasheet - production data

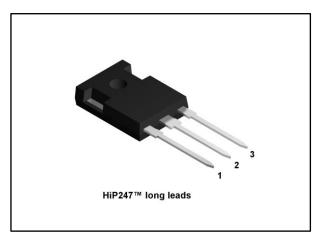
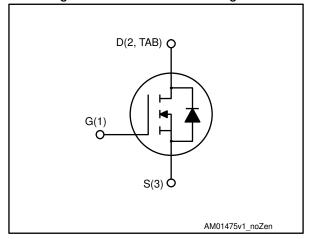


Figure 1: Internal schematic diagram



Features

- Very tight variation of on-resistance vs. temperature
- Very high operating junction temperature capability (T_J = 200 °C)
- Very fast and robust intrinsic body diode
- Low capacitance

Applications

- Solar inverters, UPS
- Motor drives
- High voltage DC-DC converters
- Switch mode power supply

Description

This silicon carbide Power MOSFET is produced exploiting the advanced, innovative properties of wide bandgap materials. This results in unsurpassed on-resistance per unit area and very good switching performance almost independent of temperature. The outstanding thermal properties of the SiC material allow designers to use an industry-standard outline with significantly improved thermal capability. These features render the device perfectly suitable for high-efficiency and high power density applications.

Table 1: Device summary

Order code	Marking	Package	Packaging
SCTWA30N120	SCT30N120	HiP247™ long leads	Tube

Contents SCTWA30N120

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SCTWA30N120 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	1200	V
V _{GS}	Gate-source voltage	-10 to 25	٧
ID	Drain current (continuous) at T _C = 25 °C (limited by die)	45	А
lσ	Drain current (continuous) at T _C = 25 °C (limited by package)	40	Α
ID	Drain current (continuous) at T _C = 100 °C	34	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	90	Α
Ртот	Total dissipation at T _C = 25 °C	270	W
T _{stg}	Storage temperature range	EE to 200	°C
Tj	Operating junction temperature range	-55 to 200	10

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	0.65	°C/W
R _{thj-amb}	Thermal resistance junction-amb	40	°C/W

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width limited by safe operating area.

Electrical characteristics SCTWA30N120

2 Electrical characteristics

(T_{case} =25 °C unless otherwise specified)

Table 4: On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
	Zoro goto voltago drain	$V_{GS} = 0 \text{ V}, V_{DS} = 1200 \text{ V}$		1	25	μΑ
I _{DSS}	Zero gate voltage drain current	V _{GS} = 0 V, V _{DS} = 1200 V, T _J =200 °C		50		μΑ
Igss	Gate-body leakage current	$V_{DS}=0 \text{ V}, V_{GS}=-10 \text{ to } 22 \text{ V}$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	1.8	3.5		>
		$V_{GS} = 20 \text{ V}, I_D = 20 \text{ A}$		80	100	mΩ
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 20 V, I _D = 20 A T _J = 150 °C		90		mΩ
resistance	V _{GS} = 20 V, I _D = 20 A T _J = 200 °C		100		mΩ	

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1700	-	pF
Coss	Output capacitance	V _{GS} =0 V, V _{DS} =400 V, f=1 MHz	-	130	-	pF
Crss	Reverse transfer capacitance	1-1 101112	-	25	-	pF
R _G	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D=0 \text{ A}$	-	5	-	Ω
Qg	Total gate charge		-	105	-	nC
Qgs	Gate-source charge	$V_{DD} = 800 \text{ V}, I_{D} = 20 \text{ A}$ $V_{GS} = 0 \text{ to } 20 \text{ V}$	-	16	-	nC
Q_{gd}	Gate-drain charge	VGS -0 10 20 V	-	40	-	nC

Table 6: Switching energy (inductive load)

,						
Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
Eon	Turn-on switching energy	$V_{DD} = 800 \text{ V}, I_D = 20 \text{ A},$	1	500	1	μJ
E _{off}	Turn-off switching energy	$R_G = 6.8 \Omega$, $V_{GS} = -2 \text{ to } 20 \text{ V}$	-	350	-	μJ
Eon	Turn-on switching energy	$V_{DD} = 800 \text{ V}, I_D = 20 \text{ A},$	1	500	1	μJ
E _{off}	Turn-off switching energy	$R_G = 6.8 \Omega$, $V_{GS} = -2 \text{ to } 20 \text{ V}$ $T_{J} = 150 \text{ °C}$	-	400	-	μJ

Table 7: Switching times

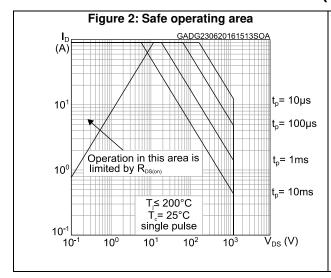
	-					
Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
t _{d(on)} v	Turn-on delay time		1	19	1	ns
t _{f(V}	Fall time	$V_{DD} = 800 \text{ V}, I_D = 20 \text{ A},$	-	28	-	ns
t _{d(off)} v	Turn-off-delay time	$R_G = 0 \Omega$, $V_{GS} = 0$ to 20 V	-	45	-	ns
t _{r(V)}	Rise time		-	20	-	ns

SCTWA30N120 Electrical characteristics

Table 8: Reverse SiC diode characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
V _{SD}	Diode forward voltage $I_F = 10 \text{ A}, V_{GS} = 0 \text{ V}$		1	3.5	1	V
t _{rr}	Reverse recovery time			140	-	ns
Qrr	Reverse recovery charge $I_{SD} = 20 \text{ A}$, di/dt = 100 A/ μ s $V_{DD} = 800 \text{ V}$		-	140		nC
I _{RRM}	Reverse recovery current	VDD= 000 V	-	2		Α

2.1 Electrical characteristics (curves)



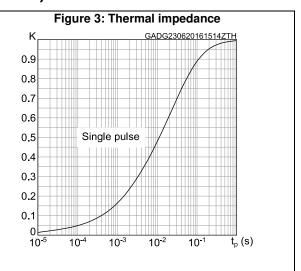
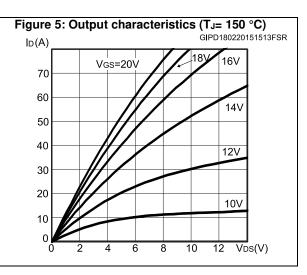
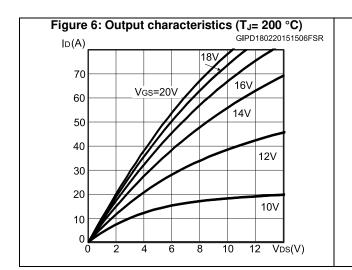
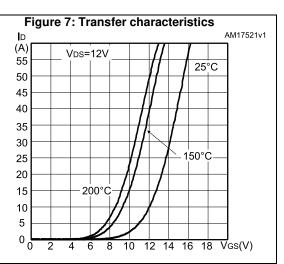
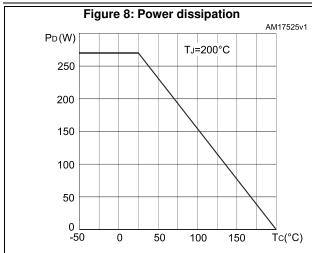


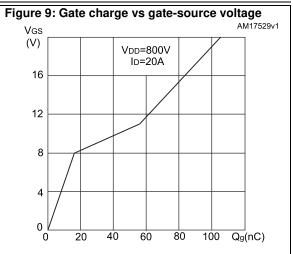
Figure 4: Output characteristics (T_J= 25 °C) I_D(A) Vgs=20V 18V 70 60 16V 50 40 30 14V 20 10 12V 10V Vps(V)

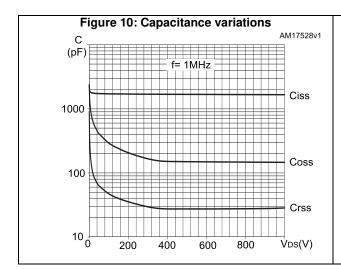


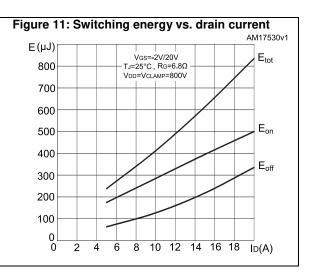


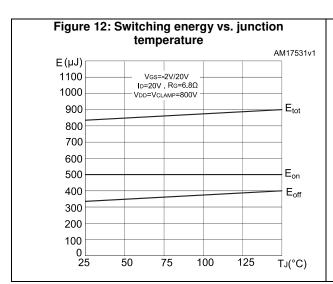


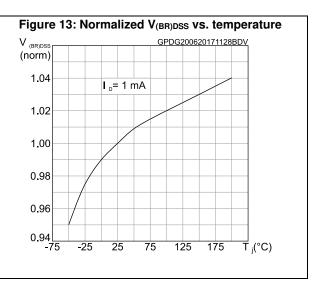












1.0

0.8

Figure 14: Normalized gate threshold voltage vs. temperature

V (GS(III) (NORM)

(NORM)

I D= 1 mA

1.2

25

-25

75

125

175

T_i(°C)

Figure 15: Normalized on-resistance vs. temperature

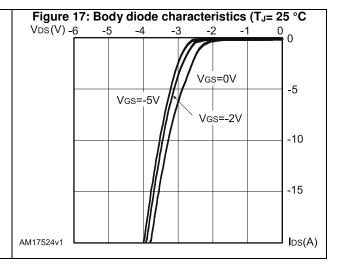
R DS(on) (NORM)

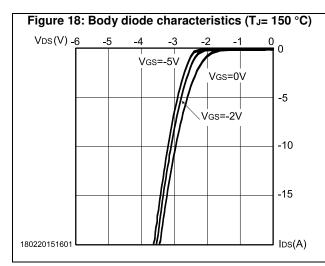
2.0 V GS= 20 V

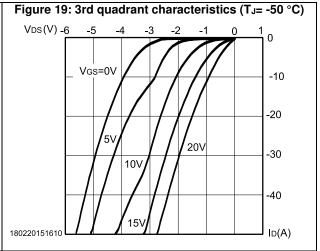
1.5

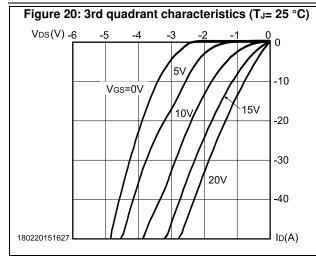
1.0 0.5

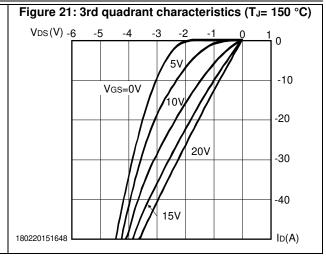
0.0 -75 -25 25 75 125 175 T (°C)











3 **Package information**

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

3.1 HiP247 long leads package information

Figure 22: HiP247™ long leads package outline

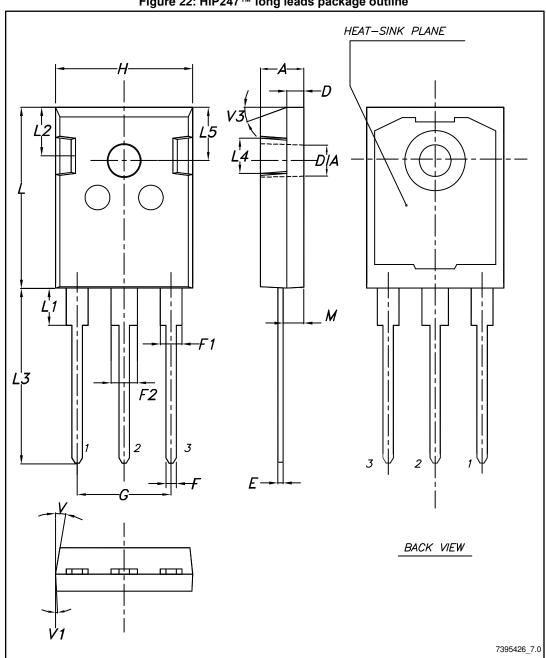


Table 9: HiP247™ long leads package mechanical data

	iong iona	mm	
Dim.	Min.	Тур.	Max.
А	4.90		5.15
D	1.85		2.10
Е	0.55		0.67
F	1.07		1.32
F1	1.90		2.38
F2	2.87		3.38
G		10.90 BSC	
Н	15.77		16.02
L	20.82		21.07
L1	4.16		4.47
L2	5.49		5.74
L3	20.05		20.30
L4	3.68		3.93
L5	6.04		6.29
М	2.25		2.55
V		10°	
V1		3°	
V3		20°	
DIA	3.55		3.66

Revision history SCTWA30N120

Revision history 4

Table 10: Document revision history

Date	Revision	Changes
11-Jan-2016	1	First release.
19-Jun-2017	2	Updated title, features in cover page. Minor text edit in Section 1: "Electrical ratings" and Section 2: "Electrical characteristics". Updated Figure 2: "Safe operating area", Figure 3: "Thermal impedance", Figure 13: "Normalized V(BR)DSS vs. temperature", Figure 14: "Normalized gate threshold voltage vs. temperature" and Figure 15: "Normalized on-resistance vs. temperature". Document status promoted from preliminary to production data.

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